DGTD65T60S2PT

650V FIELD STOP IGBT IN TO247

Description

The DIODES™ DGTD65T60S2PT is produced using advanced Field Stop Trench IGBT 2nd Generation Technology, which not only gives high-switching efficiency, but is also extremely rugged and excellent quality for applications where low conduction losses are essential.

Features

- High Speed Switching & Low Power Loss
- $V_{CE(sat)}$ = 1.85V @ I_C = 60A
- High Input Impedance
- t_{rr} = 110ns (Typ) @ dI_F/dt = 500A/µs
- E_{off} = 0.53mJ @ T_C = +25°C
- Maximum Junction Temperature +175°C
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

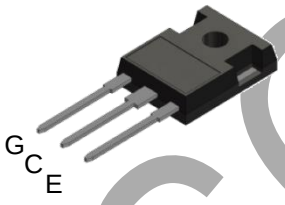
Applications

- UPS
- Welders
- Solar inverters
- IH cookers

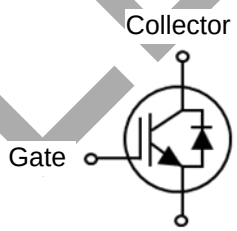
Mechanical Data

- Package: TO247
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 5.6 grams (Approximate)

TO247 (Type MC)



Top View



Device Symbol

Ordering Information (Note 4)

Part Number	Package	Marking	Packing	
			Qty.	Carrier
DGTD65T60S2PT	TO247 (Type MC)	DGTD65T60S2	450	Per Box in Tubes (Note 5)

Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
5. 30 devices per tube.

Marking Information

= Manufacturer's Marking
DGTD65T60S2 = Product Type Marking Code
YY = Year (ex: 22 = 2022)
LLLLL = Lot Code
WW = Week (01 to 53)

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Collector-Emitter Voltage		V_{CE}	650	V
DC Collector Current, Limited by T_{vjmax}	T_C = +25°C	I_C	100	A
	T_C = +100°C		60	A
Pulsed Collector Current, t_p Limited by T_{vjmax}		I_{Cpuls}	180	A
Turn Off Safe Operating Area $V_{CE} \leq$ 650V, T_{vj} = +175°C		—	180	A
Diode Forward Current Limited by T_{vjmax}	T_C = +25°C	I_F	60	A
	T_C = +100°C		30	A
Diode Pulsed Current, t_p Limited by T_{vjmax}		I_{Fpuls}	200	A
Gate-Emitter Voltage		V_{GE}	±20	V
Short Circuit Withstand Time $V_{CC} \leq$ 400V, R_G = 7Ω, V_{GE} = 15V, T_{vj} = +150°C Allowed Number of Short Circuits < 1000 Time Between Short Circuits ≥ 1.0s		t_{sc}	5	µs

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 6)	T_C = +25°C	P_D	428	W
	T_C = +100°C		214	
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	40	°C/W
Thermal Resistance, Junction to Case for IBGT (Note 6)		$R_{\theta JC}$	0.35	
Thermal Resistance, Junction to Case for Diode (Note 6)		$R_{\theta JC}$	1.20	
Operating Temperature		T_{vj}	-40 to +175	°C
Storage Temperature Range		T_{STG}	-55 to +150	

Note: 6. When mounted on a standard JEDEC 2-layer FR-4 board.

Electrical Characteristics (@T_{vj} = +25°C, unless otherwise specified.)

Parameter		Symbol	Min	Typ	Max	Unit	Condition
STATIC CHARACTERISTICS							
Collector-Emitter Breakdown Voltage		BV_{CES}	650	—	—	V	I_C = 2mA, V_{GE} = 0V
Collector-Emitter Saturation Voltage	T_{vj} = +25°C	$V_{CE(sat)}$	—	1.85	2.40	V	I_C = 60A, V_{GE} = 15V
	T_{vj} = +175°C		—	2.60	—		
Diode Forward Voltage	T_{vj} = +25°C	V_F	—	1.45	2.00	V	V_{GE} = 0V, I_F = 25A
	T_{vj} = +175°C		—	1.35	—		
Gate-Emitter Threshold Voltage		$V_{GE(th)}$	4.0	5.0	6.0	V	V_{CE} = V_{GE}, I_C = 0.5mA
Zero Gate Voltage Collector Current		I_{CES}	—	—	40	μA	V_{CE} = 650V, V_{GE} = 0V
Gate-Emitter Leakage Current		I_{GES}	—	—	±100	nA	V_{GE} = 20V, V_{CE} = 0V
DYNAMIC CHARACTERISTICS							
Total Gate Charge		Q_g	—	95	—	nC	V_{CE} = 520V, I_C = 60A V_{GE} = 15V
Gate-Emitter Charge		Q_{ge}	—	19	—		
Gate-Collector Charge		Q_{gc}	—	47	—		
Input Capacitance		C_{ies}	—	2,327	—	pF	V_{CE} = 25V, V_{GE} = 0V f = 1MHz
Reverse Transfer Capacitance		C_{res}	—	55	—		
Output Capacitance		C_{oes}	—	270	—		
Internal Emitter Inductance Measured 5mm (0.197") from Case		L_E	—	13	—	nH	—
SWITCHING CHARACTERISTICS							
Turn-on Delay Time		$t_{d(on)}$	—	42	—	ns	V_{GE} = 15V, V_{CC} = 400V I_C = 60A, R_G = 7Ω Inductive Load T_{vj} = +25°C
Rise Time		t_r	—	54	—		
Turn-off Delay Time		$t_{d(off)}$	—	142	—		
Fall Time		t_f	—	40	—		
Turn-on Switching Energy		E_{on}	—	0.92	—	mJ	
Turn-off Switching Energy		E_{off}	—	0.53	—		
Total Switching Energy		E_{ts}	—	1.45	—		
Reverse Recovery Time		t_{rr}	—	110	—	ns	I_F = 25A dI_F/dt = 500A/μs T_{vj} = +25°C
Reverse Recovery Current		I_{rr}	—	18	—	A	
Reverse Recovery Charge		Q_{rr}	—	1.10	—	μC	
Turn-on Delay Time		$t_{d(on)}$	—	45	—	ns	V_{GE} = 15V, V_{CC} = 400V I_C = 60A, R_G = 7Ω Inductive Load T_{vj} = +175°C
Rise Time		t_r	—	58	—		
Turn-off Delay Time		$t_{d(off)}$	—	152	—		
Fall Time		t_f	—	35	—		
Turn-on Switching Energy		E_{on}	—	1.43	—	mJ	
Turn-off Switching Energy		E_{off}	—	0.53	—		
Total Switching Energy		E_{ts}	—	1.96	—		
Reverse Recovery Time		t_{rr}	—	205	—	ns	I_F = 25A dI_F/dt = 500A/μs T_{vj} = +175°C
Reverse Recovery Current		I_{rr}	—	25	—	A	
Reverse Recovery Charge		Q_{rr}	—	2.67	—	μC	

Typical Performance Characteristics (@T_A = +25°C, unless otherwise specified.)

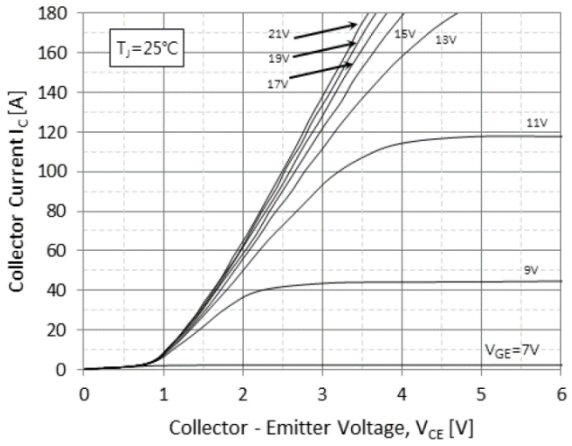


Fig.1 Typical Output Characteristics(T_J=25℃)

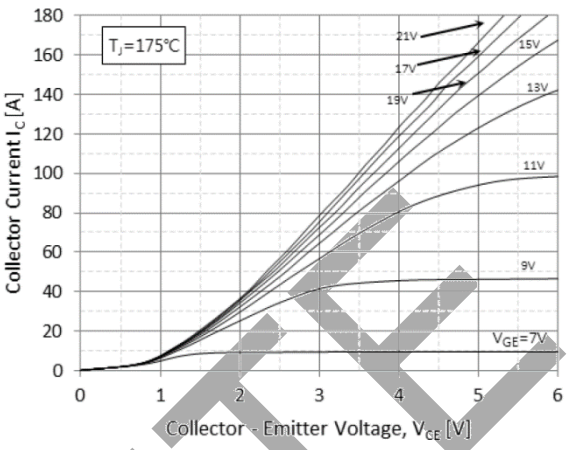


Fig.2 Typical Output Characteristics(T_J=175℃)

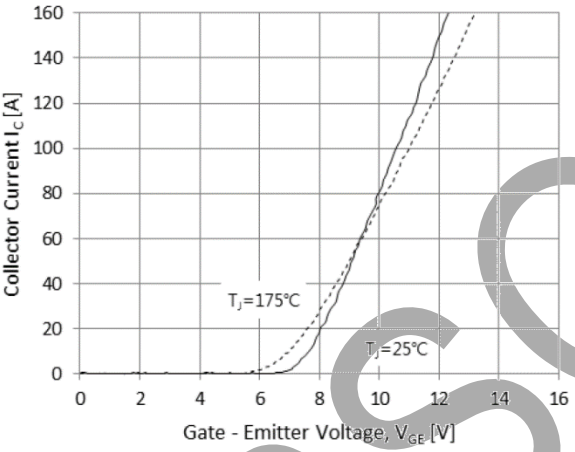


Fig.3 Typical Transfer Characteristics

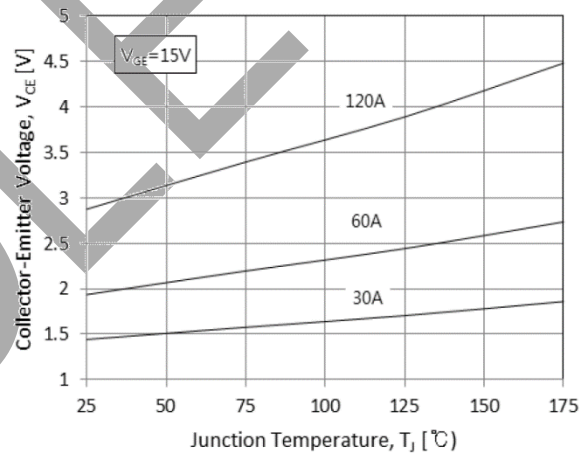


Fig.4 Typical Collector-Emitter Saturation Voltage -Junction Temperature

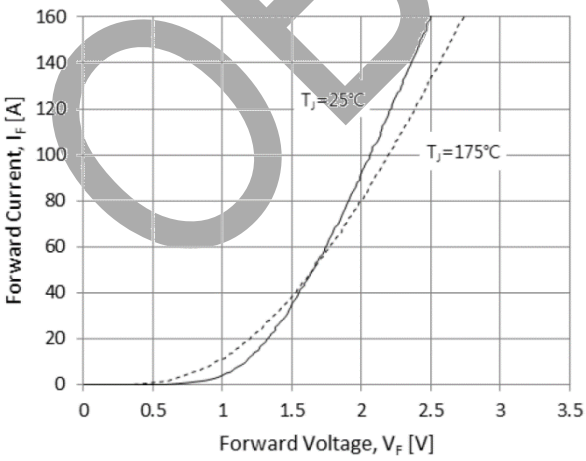


Fig.5 Diode Forward Characteristics

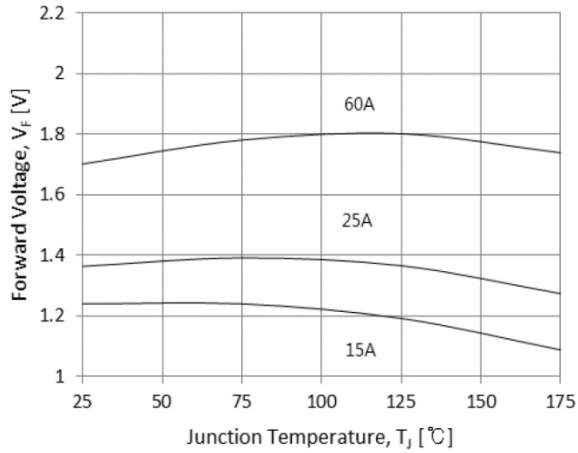


Fig.6 Diode Forward-Junction Temperature

Typical Performance Characteristics (continued)

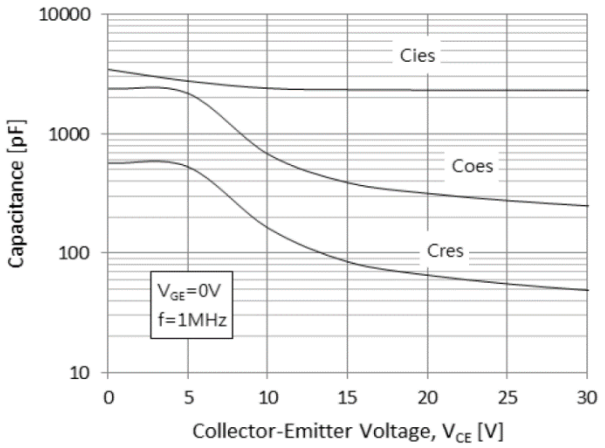


Fig.7 Typical Capacitance

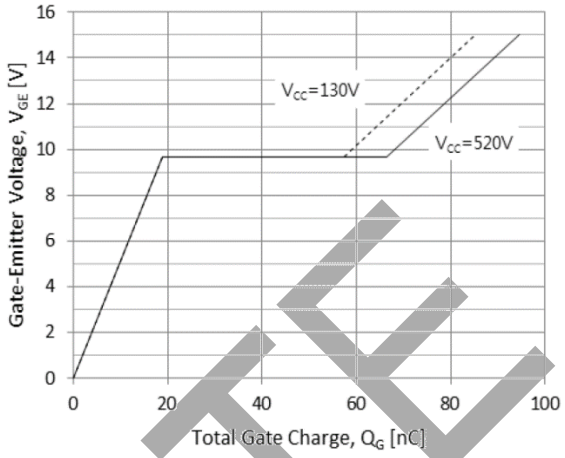


Fig.8 Typical Gate Charge

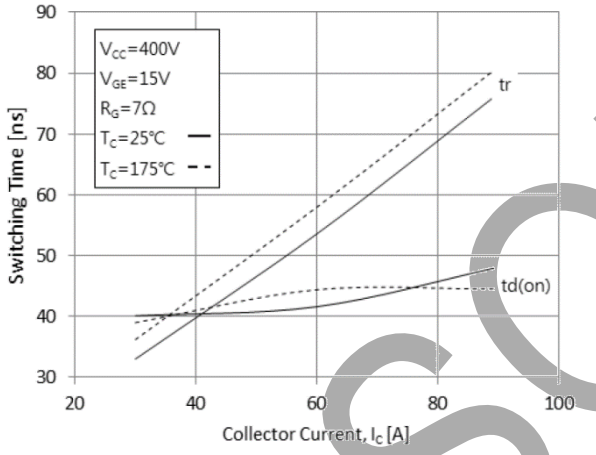


Fig.9 Typical Turn on-Collector Current

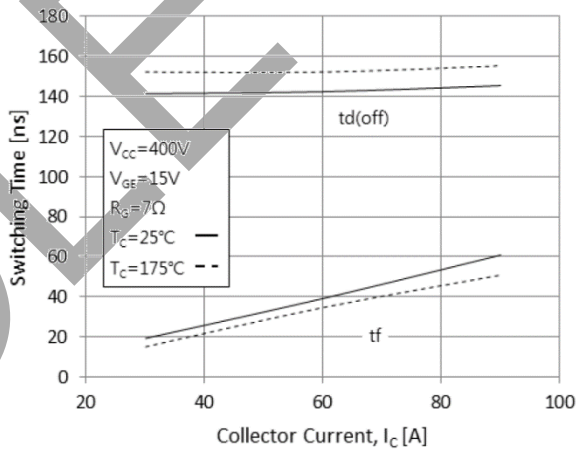


Fig.10 Typical Turn off-Collector Current

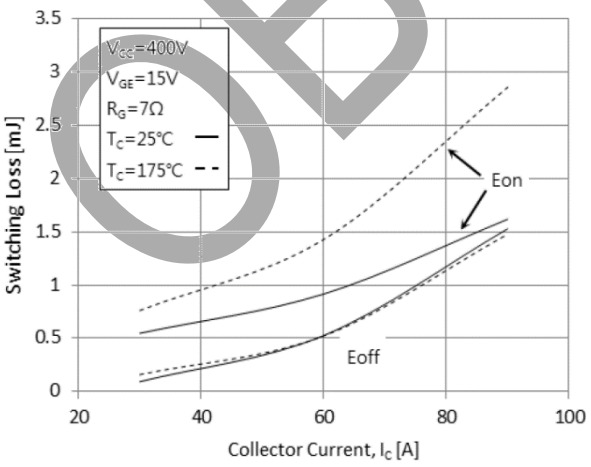


Fig.11 Switching Loss-Collector Current

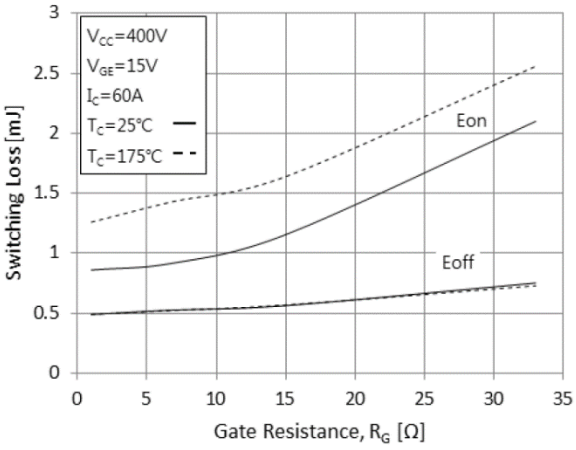


Fig.12 Switching Loss-Gate Resistance

Typical Performance Characteristics (continued)

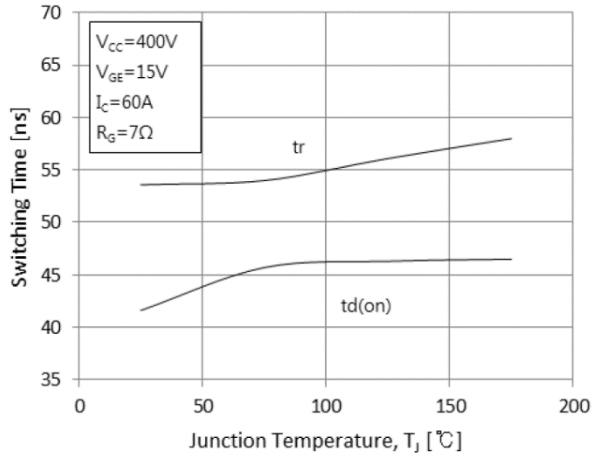


Fig.13 Turn on Characteristics-Junction Temperature

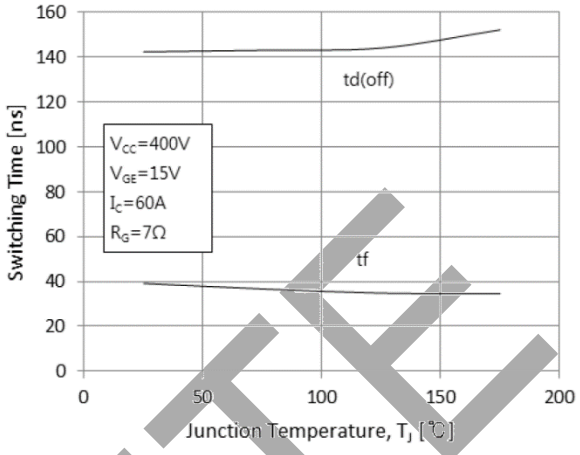


Fig.14 Turn off Characteristics-Junction Temperature

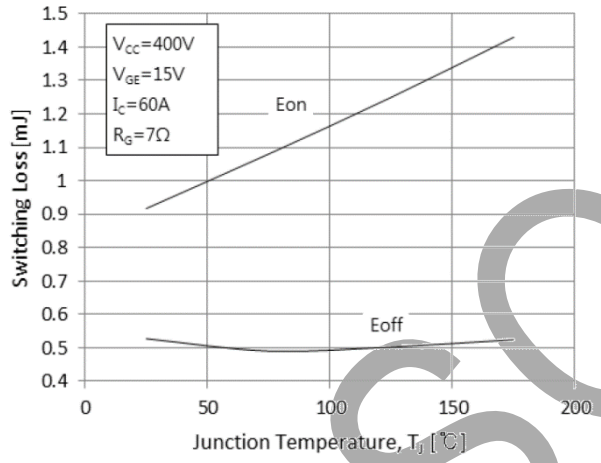


Fig.15 Switching Loss-Junction Temperature

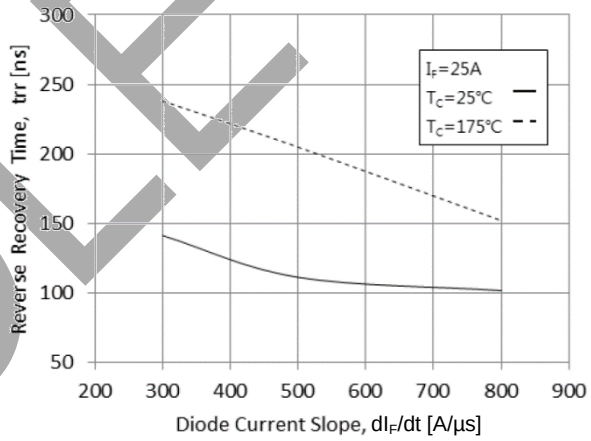


Fig.16 Reverse Recovery Time
- Diode Current Slope

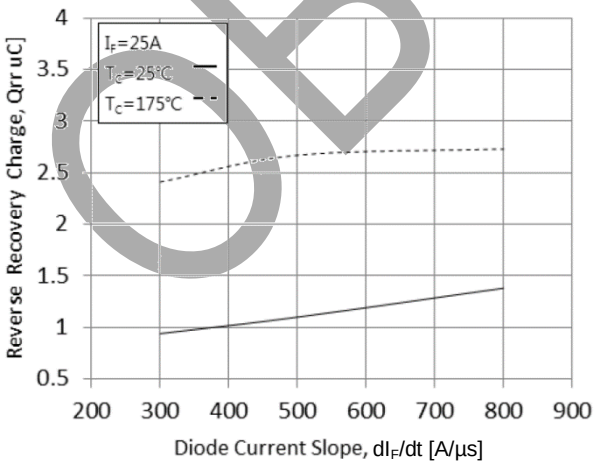


Fig.17 Reverse Recovery Charge
- Diode Current Slope

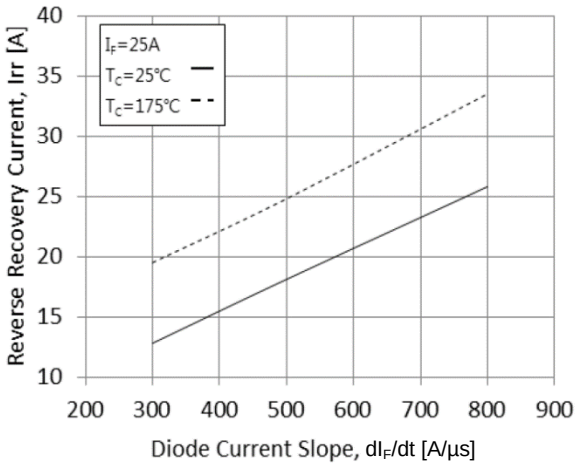


Fig.18 Reverse Recovery Current
- Diode Current Slope

Typical Performance Characteristics (continued)

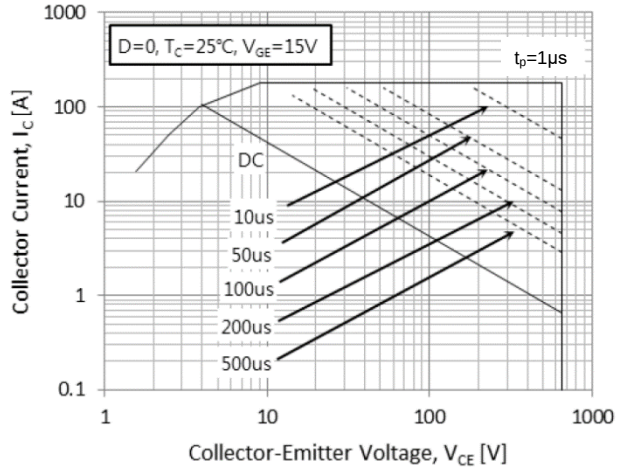


Fig.19 Forward Bias Safe Operating Area

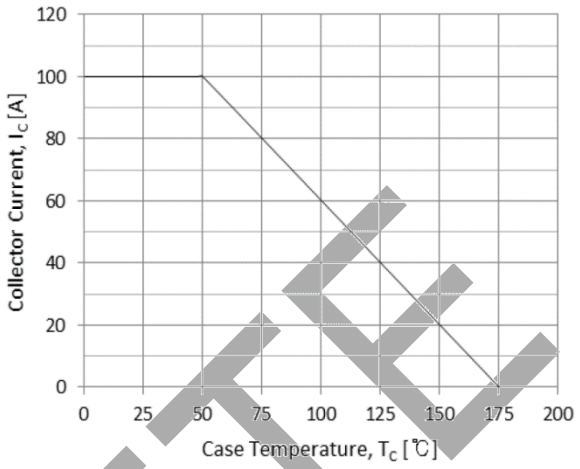


Fig.20 Case Temperature-Collector Current

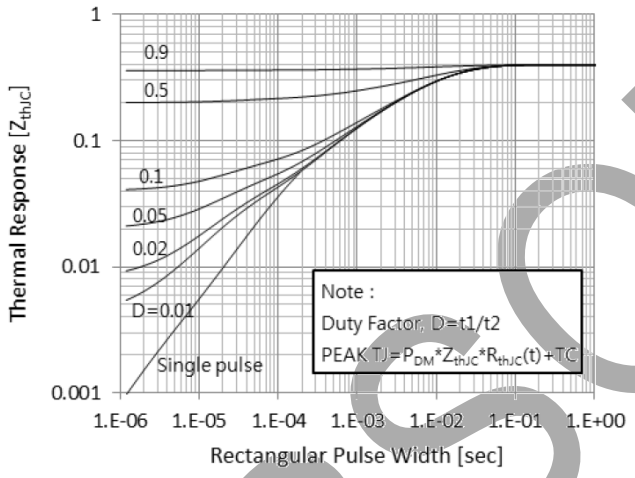


Fig.21 IGBT Transient Thermal Impedance

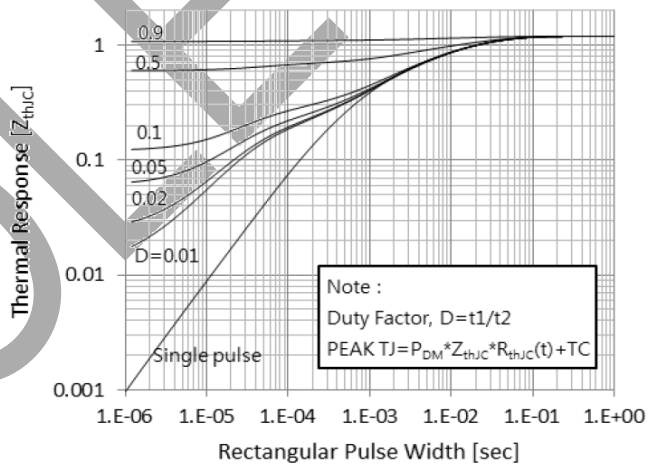
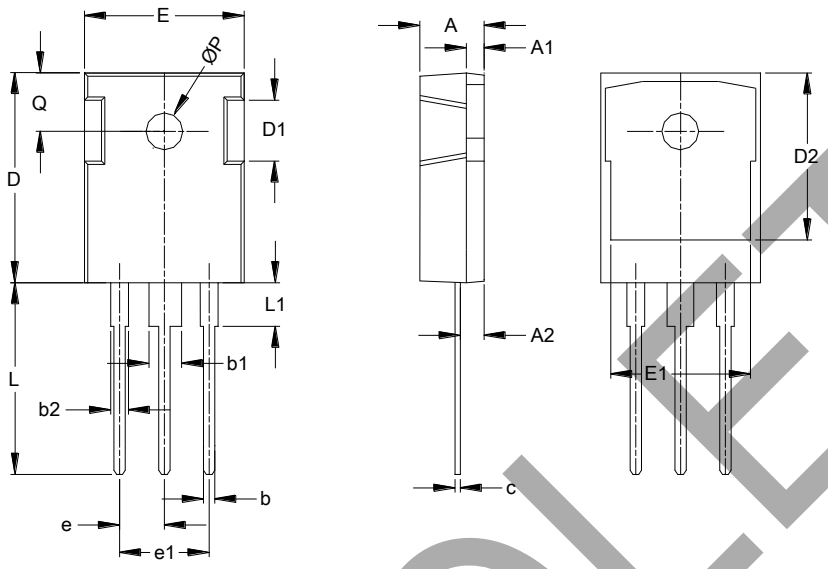


Fig.22 FRD Transient Thermal Impedance

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO247 (Type MC)



TO-247 (Type MC)			
Dim	**Min**	**Max**	**Typ**
A	4.700	5.310	-
A1	1.500	2.490	-
A2	2.200	2.600	-
b	0.990	1.400	-
b1	2.590	3.430	-
b2	1.650	2.390	-
c	0.380	0.890	-
D	20.30	21.46	-
D1	4.320	5.490	-
D2	13.08	-	-
E	15.45	16.26	-
E1	13.06	14.02	-
e	5.450		
e1	10.90		
L	19.81	20.57	-
L1	-	4.500	-
Q	5.380	6.200	-
øP	3.500	3.700	-
All Dimensions in mm			

Note: 7. For high-voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.

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